



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

October 8, 2009

Applicants: Atsushi YABE et al

Title: ELECTROLESS COPPER PLATING SOLUTION

Serial No.: 10/576 231

Group: 1792

Confirmation No.: 7188

Filed: April 14, 2006

Examiner: Bareford

International Application No.: PCT/JP2004/011327

International Filing Date: July 30, 2004

Atty. Docket No.: 4700.P0327US

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

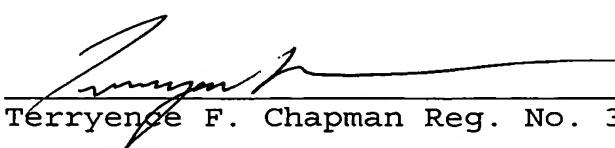
Herewith is an amendment in the above-identified application.

Applicant claims small entity status. See 37 CFR 1.27.
 The additional filing fee has been calculated as shown below:

| For | No. Filed | No. Extra | (X) LG Entity | RATE | () | SM Entity | Fee |
|------------------------------|--------------|-----------|---------------|------|------------|-----------|---------|
| Total Claims | (8 - 20 = 0) | | x \$ 52.00 | | x \$ 26.00 | | |
| Indep. Claims | (3 - 3 = 0) | | x \$220.00 | | x \$110.00 | | |
| [] Multiple Dep. Claim | | | + \$390.00 | | + \$195.00 | | |
| * * * TOTAL FILING FEE * * * | | | | | | | \$ 0.00 |

Pursuant to 37 CFR 1.136(a), please extend the shortened period for response by month(s). The extension fee is: \$.
 A Check for \$ is enclosed to cover fees.
 Please credit any overpayment, or charge any additional filing fee required under 37 CFR 1.16 or 1.17 by this communication, to Deposit Account No. 06-1382.

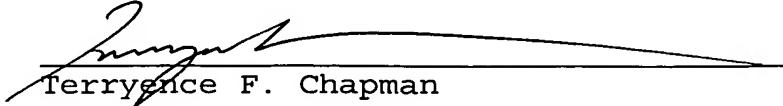
TFC/smd


Terryence F. Chapman Reg. No. 32 549

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on October 8, 2009.

130.10/08


Terryence F. Chapman